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Bib Data Sheet

CONFIRMATION NO. 8260

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|---|---|-------------------------------|---|---|
| SERIAL NUMBER 09/829,161 | FILING DATE 04/09/2001 RULE | CLASS 257 | GROUP ART UNIT 2811 | ATTORNEY DOCKET NO. 3442.1US (96-428.1) |
| APPLICANTS Salman Akram, Boise, ID; ** CONTINUING DATA ***** THIS APPLICATION IS A DIV OF 09/388,031 09/01/1999 ** FOREIGN APPLICATIONS ***** <i>none</i> IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 08/30/2001 | | | | |
| Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no 35 USC 119 (a-d) conditions <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after met Allowance Verified and <i>th</i> Acknowledged Examiner's Signature Initials | | STATE OR COUNTRY ID | SHEETS DRAWING 14 | TOTAL CLAIMS 71 |
| INDEPENDENT CLAIMS 3 | | | | |
| ADDRESS 24247 | | | | |
| TITLE Metallization structures for semiconductor device interconnects, methods for making same, and semiconductor devices including same | | | | |
| FILING FEE RECEIVED 1628 | FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following: | | <input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit | |